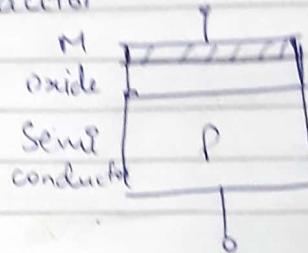


L#

wed 6-7 pm (office hours)

Page No.:

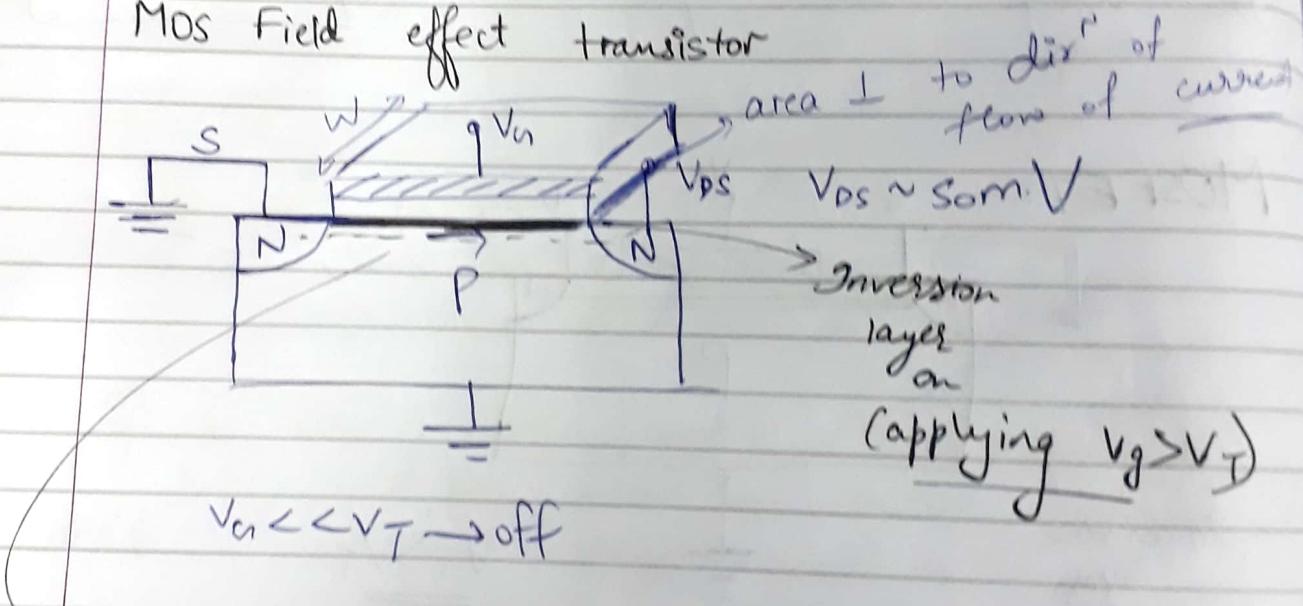
MOS Capacitor



$V_G > V_T \rightarrow \text{Inversion}$

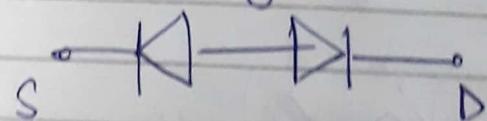
$$Q_I = Cox(V_G - V_T)$$

MOS Field effect transistor



$V_G \ll V_T \rightarrow \text{off}$

device along dotted line



$\rightarrow \text{No current}$

unless you break down the diode

$V_G > V_T \rightarrow \text{Inversion layer}$

diffusion \rightarrow negligible
 charge is changing very less
 charge is mainly due to drift, therefore current $\propto V$
 when we move to drain side, there can be some potential V_D
 as e is moving to higher potential ie lower energy

$$\star Q_I(S) = C_{ox} (V_{DS} - V_T)$$

$$\star Q_I(D) = C_{ox} (V_{DS} - V_T - V_{DS})$$

$$I = \rho V$$

$$= \langle \rho \rangle \langle v \rangle$$

q * velocity

$$v = \mu E$$

velocity = mobility * electric field (definition of mobility)

$$I = \cancel{C_{ox}} \left(V_{DS} - V_T - \frac{V_{DS}}{2} \right) \left(\mu \frac{V_{DS}}{L} \right) \quad \langle v \rangle = \mu \frac{V_{DS}}{L}$$

In linear region

\hookrightarrow doesn't take into account width

Text

$\parallel \rho \rightarrow \int d\rho$

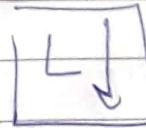
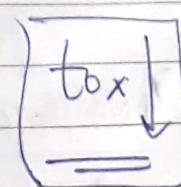
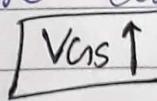
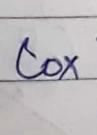
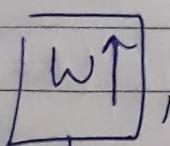
to the depth
should by x will

$$I = \frac{\mu}{L} W C_{ox} \left(V_{DS} - V_T - \frac{V_{DS}}{2} \right) \left(\frac{V_{DS}}{L} \right)$$

* for a switch drop \rightarrow should very small

$$I \approx \underline{C_{ox} \mu W} \left(V_{DS} - V_T \right) \left(\frac{V_{DS}}{L} \right) \quad \left\{ \begin{array}{l} \text{for very small } \\ V_{DS} \end{array} \right\}$$

~~for~~ to have more current we ~~can~~ can



but we avoid this

current $\propto V_{DS}$

\rightarrow kind of a resistor.

$$\left\{ I = \frac{C_{ox} M W}{L} \left(V_{DS} - V_T - \frac{V_{DS}}{2} \right) (V_{DS}) \right\}$$

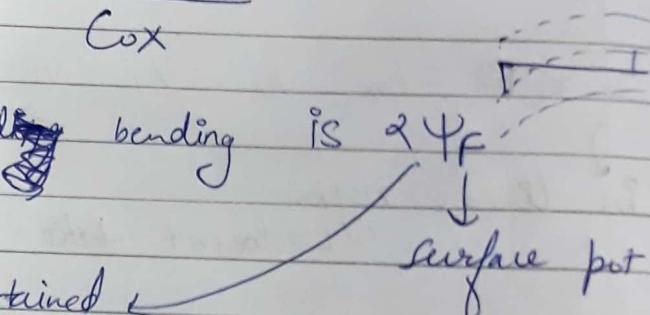
(8) P-type doping 10^{16} cm^{-3} | $t_{ox} = 3 \text{ nm}$
 $t_{ox} = 3.9 \times 8.854 \times 10^{-14}$

(8) V_T | (8) W_{dep} width | (8) C_V

$$V_T = \varphi \psi_F + \left[\frac{4 \epsilon_s q N_A \psi_F}{C_{ox}} \right]^{1/2}$$

V_T occurs when band bending is $\varphi \psi_F$

can be obtained from doping



$$\psi_F = \frac{kT \ln \left(\frac{N_A}{N_D} \right)}{q} =$$

$$V_G = \psi_s + \frac{\psi_s}{C_{ox}}$$

$$\epsilon \frac{d^2 \psi}{dx^2} = \epsilon E \frac{dE}{d\psi} = -q(\rho - n - N_A)$$

$$V_T = \varphi \psi_F + \frac{\sqrt{4 N_A q \epsilon_s \psi_F}}{C_{ox}}$$

$$\psi_s^2 = \frac{\epsilon_s^2 E^2}{\epsilon} = 2(N_A)q\epsilon_s\psi_s$$

$$\psi_s = \sqrt{2 N_A q \epsilon_s (\psi_s)}$$

$$V_T = 2 \left(\frac{k_T}{q_i} \right) \ln \left(\frac{N_A}{n_i} \right) + \frac{\sqrt{4 \times N_A \times 11.8 \times 60} \times \Psi_F \times q}{\epsilon_{ox}}$$

\downarrow
 $\frac{\epsilon_{ox}}{t_{ox}}$

$$\underline{\underline{\Psi_F = .357}}$$

$$V_T = 2 (.357) + \frac{\sqrt{4 \times }}{}$$

$$= 2 (.357) + \frac{(4.088 \times 10^{-8}) (3 \times 10^{-9})}{3.9 \times 60}$$

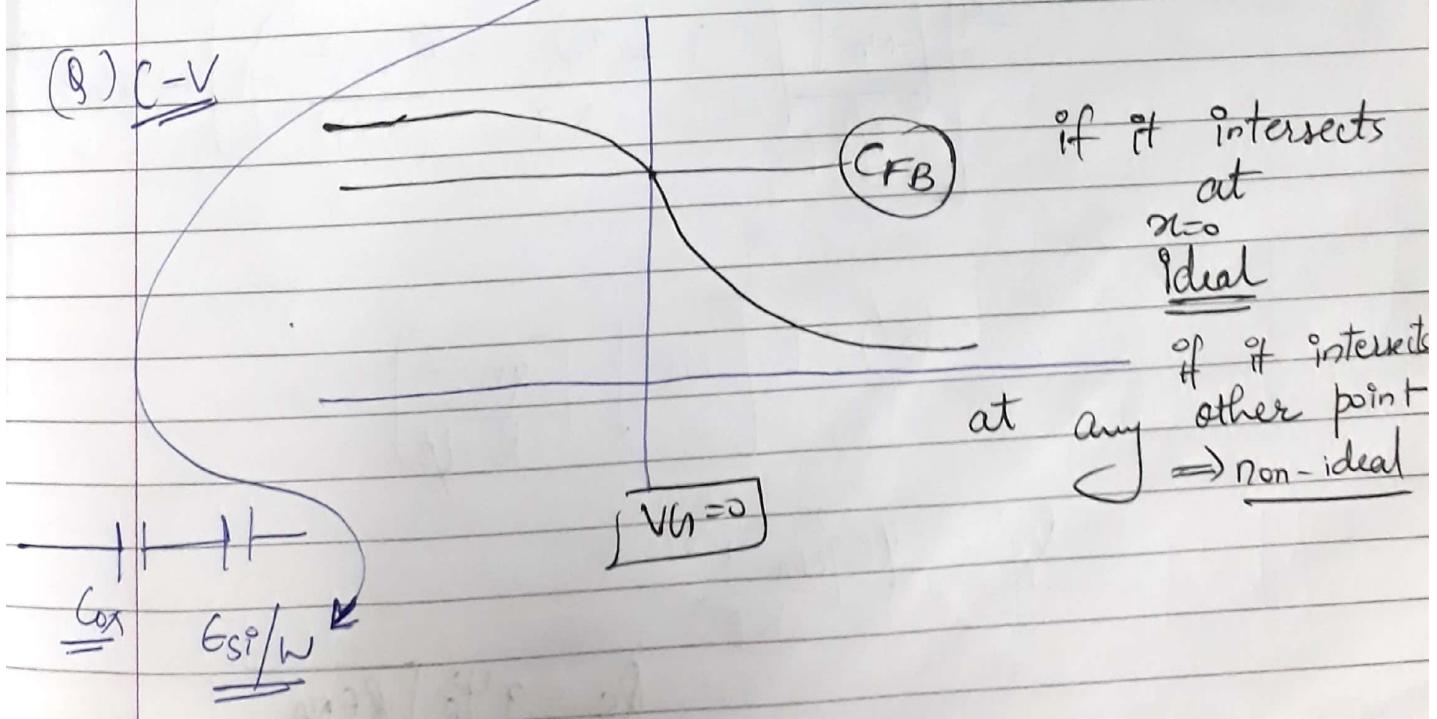
$$= 2 (.357) + 4.24 \times 10^{-9}$$

$$= \underline{\underline{.7144 V}}$$

(8) W depletion region width

$$Q_s = q N_A W$$

(8) C-V



$$V_T = 2 \left(\frac{k_T}{q} \right) \ln \left(\frac{N_A}{n_i} \right) + \frac{\sqrt{4 \times N_A \times 11.8 \times 6 \times \Psi_F \times q}}{e_{ox}}$$

\downarrow
 $\frac{e_{ox}}{t_{ox}}$

$$\underline{\underline{\Psi_F = .357}}$$

$$V_T = 2 (.357) + \frac{\sqrt{4 \times }}{}$$

$$= 2 (.357) + \frac{(4.88 \times 10^{-8}) (3 \times 10^{-9})}{3.9 \times 6}$$

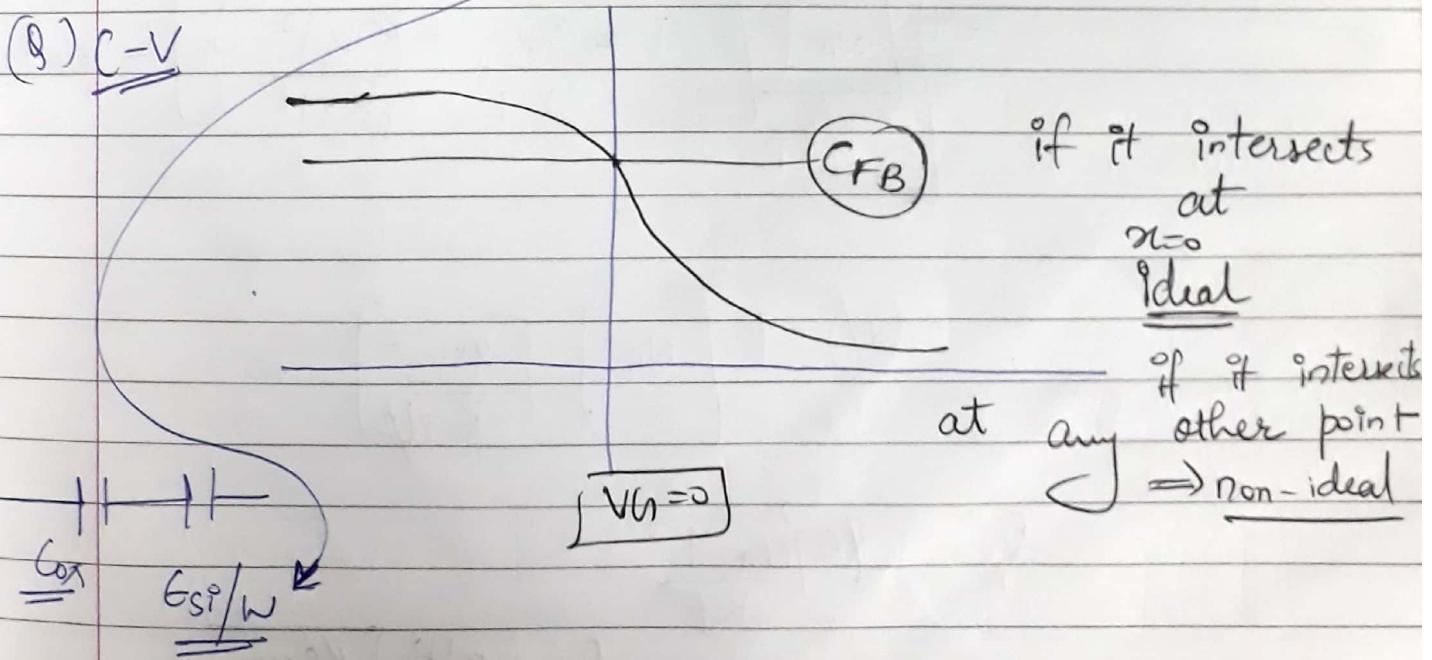
$$= 2 (.357) + 4.24 \times 10^{-9}$$

$$= \underline{\underline{.7144 V}}$$

(Q) W depletion region width

$$Q_s = q N_A W \quad \checkmark$$

(Q) C-V



CFB

CFB → flat band

$V_{bi} = 0$
ac source

$$Q_s^2 = \epsilon_s^2 E_s^2 - (2e) - 9 \int_{\psi_s}^{\infty} (p - n - N) d\psi$$

\downarrow
dominant charge
 $n \rightarrow \text{minority}$

$$P \rightarrow NAE$$
$$-9\psi/kT$$

$$(2e) - 9 \left[\frac{-NA \left(e^{-9\psi_s/kT} - 1 \right)}{9/kT} - NA\psi_s \right]$$

$$= -9 \left[\frac{[-NA]}{9/kT} \left[\left(1 - \frac{9\psi_s}{kT} + \frac{(9\psi_s)^2}{(kT)^2} - 1 \right) \right] - NA\psi_s \right]$$

$$= (2e) + 9 \left[NA \right] \left[\frac{9\psi_s^2}{kT} \right]$$

$$Q_s^2 = \frac{8e9^2 N_A \psi_s^2}{K_T}$$

$$Q_s = 9\psi_s \sqrt{8eN_A}$$

L#

$$I = \mu_{\text{Cox}} \frac{W}{L} \left[(V_{GS} - V_T) V_{DS} - \frac{V_{DS}^2}{2} \right]$$

$$Q_I = C_{\text{ox}} (V_G - V_{DS} - V_T) \leftarrow$$

S → terminal through which carrier enters (supplies the carrier)

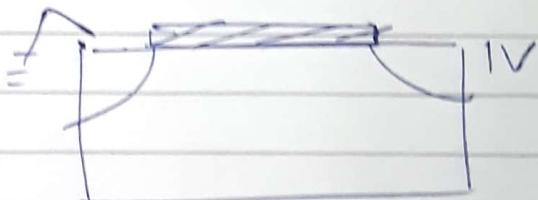
Drain → (terminal through which you take out carrier)

(1) $V_G \ll V_T$

(2) $V_G \gg V_T, V_{DS} =$

(3) $V_G \gg V_T$

V_D is small ✓



MOSFET

① Sub-Threshold $V_G < V_T$

② Linear $V_G > V_T$,

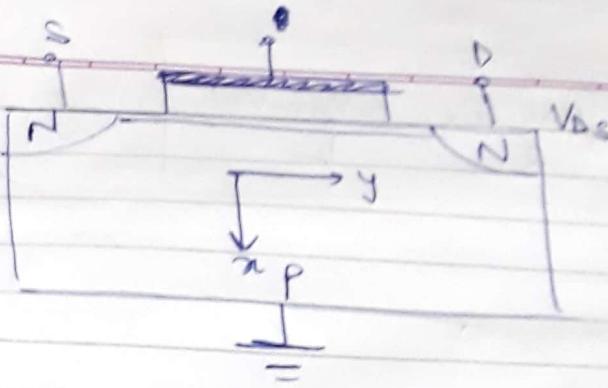
③ Sat $V_G > V_T$

$$V_{DS} < V_G - V_T$$

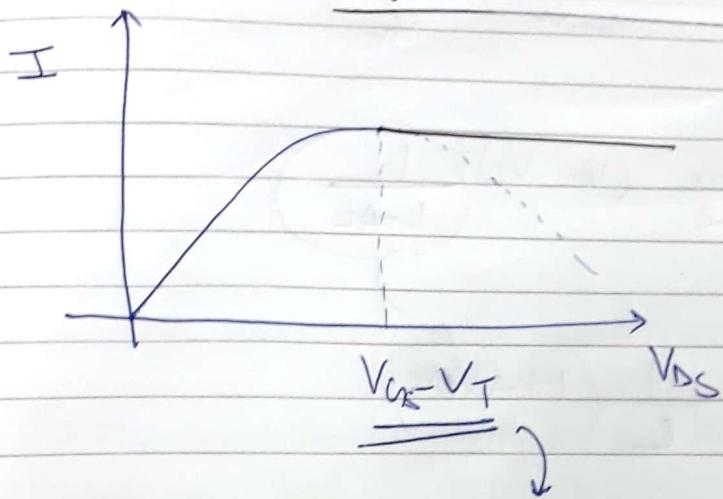
$$V_{DS} > V_G - V_T$$

$$I = \mu_{\text{Cox}} \frac{W}{L} \left((V_G - V_T) V_{DS} - \frac{V_{DS}^2}{2} \right)$$

Valid only when inversion ~~channel~~ layer is through the channel

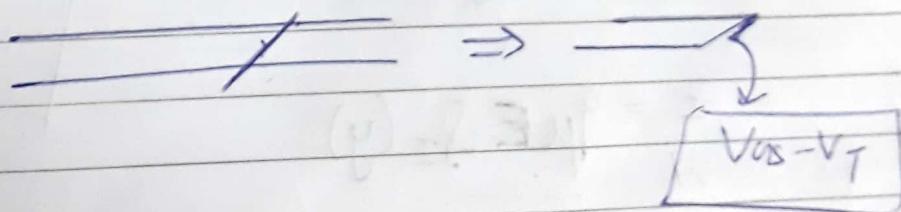
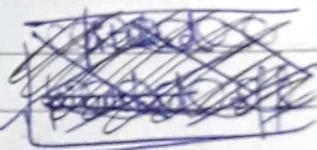


$$g_I = C_{ox} (V_{DS} - V_T - V_{G(y)})$$



the linear eqⁿ is valid only when inversion layer is through the channel.

- After $V_{DS} - V_T$, inversion layer gets pinched off.



modification in I :

$$I = \frac{\mu W C_{ox}}{2} (V_{DS} - V_T) \left(\frac{V_{DS} - V_T}{L} \right)$$

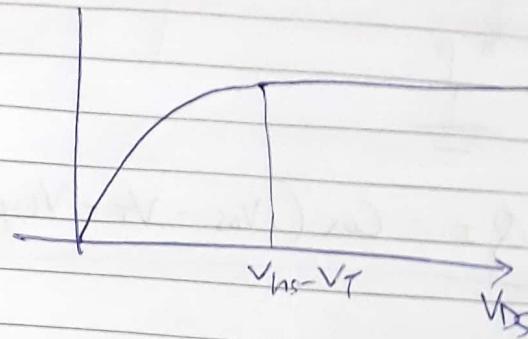
c
after pinch off further increase in V_D does not effect potential at end of channel

~~if Long channel than $L \approx L'$~~

$L' \approx L$ \rightarrow depletion length due to $p-n$

$$I_{sat} = \frac{\mu w C_{ox}}{2} \frac{(V_{ds} - V_T)^2}{L}$$

long channel



(ques)

$$I_{sat} = \frac{\mu w C_{ox}}{2} \frac{(V_{ds} - V_T)^2}{L - \Delta L}$$

$$\frac{1}{L} (1 + \lambda V_{ds})$$

$$L' = \frac{L}{1 + \lambda V_{ds}}$$

$\lambda \rightarrow$ accounts for

$$\frac{I}{W} = q \mu E \int_0^L n dx$$

no of minority carriers

Total charge \times Velocity
current

$$\frac{I}{W} = q \mu E Q_I(y)$$

$$\frac{I}{W} = \mu \frac{dv}{dy} Q_I(y)$$

$$\int_0^L \frac{I}{w} dy = \int_0^{V_{DS}} \mu Q_I(y) dv$$

(Ques) $V_T = 0.7$

$V_{DS} < V_D - V_T \rightarrow \text{Linear}$

$V_{DS} > V_D - V_T \rightarrow \text{sat.}$

$V_{DS} (V)$	$V_{DS} (v)$	
2	3	→ Linear
5	2	→ Sat
0	3	→ Linear
0	0.5	→ Cutoff / sub-threshold

(g) $\frac{\mu W L \alpha}{L} = I_m A / v^2$

sat

5mA can be supported in breakdown regime. Fig. and terminal bias. $V_T = 0.7$ (with $\lambda = 0$)

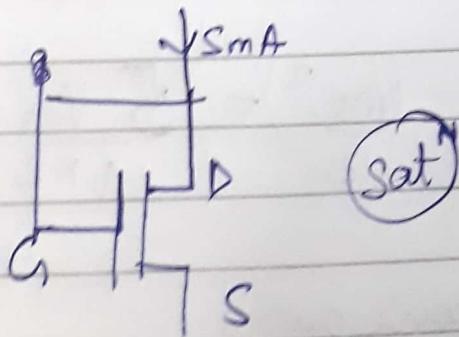
$$S = 1 (V_{DS} - V_T)^2 (1 + 0)$$

$$(V_{DS} - V_T)^2 = S$$

$$V_{DS} = V_T + \sqrt{S}$$

$$V_{DS} = 2.036 + 0.7$$

$$V_{DS} = 2.936$$

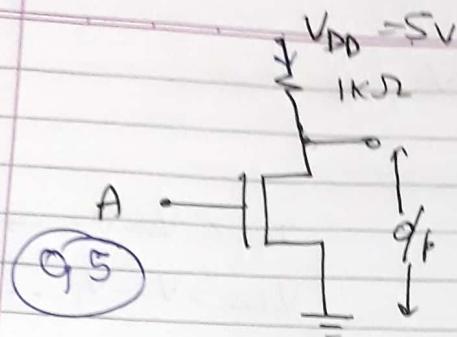


drain & gate are shorted

$$V_{DS} = V_{DS}$$

$$\Rightarrow V_{DS} > V_{DS} - V_T$$

(Q)



A	0/b
0	5
S	0.75

Load \rightarrow capacitive

A=0

, Sub-threshold
Current \Rightarrow Capacitive load

Assume Sat. & check w.r.t. assumption

$$I_{sat} = 0.05 \left(V_{DS} - V_T \right)^2$$

$$I_{sat} = 0.5 \left(4.3 \right)^2$$

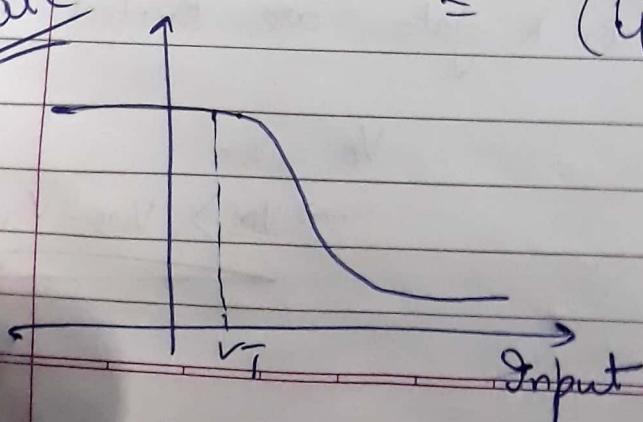
$$\frac{V_{DD} - V_{DS}}{1K} = I$$

\checkmark
Sat

$$\rightarrow I = I \left((V_D - V_T) (V_{DS}) - \frac{(V_{DS})^2}{2} \right)$$

$$= (4.3 V_{DS} - \frac{(V_{DS})^2}{2}) = \frac{5 - V_{DS}}{1 K}$$

~~Not gate~~



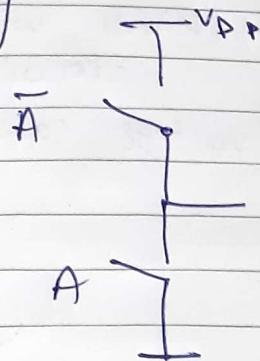
turns on
in saturation
region

To reduce V , but that will increase time, we can increase resistance T of capacitor.

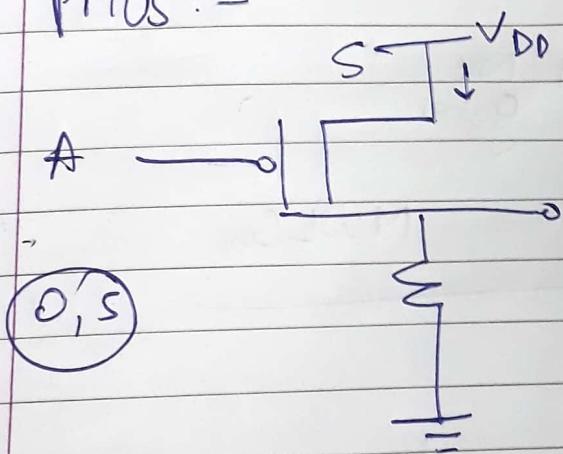
$$\hookrightarrow T = RC$$

So charging time will increase.

Ideally



PMOS :-

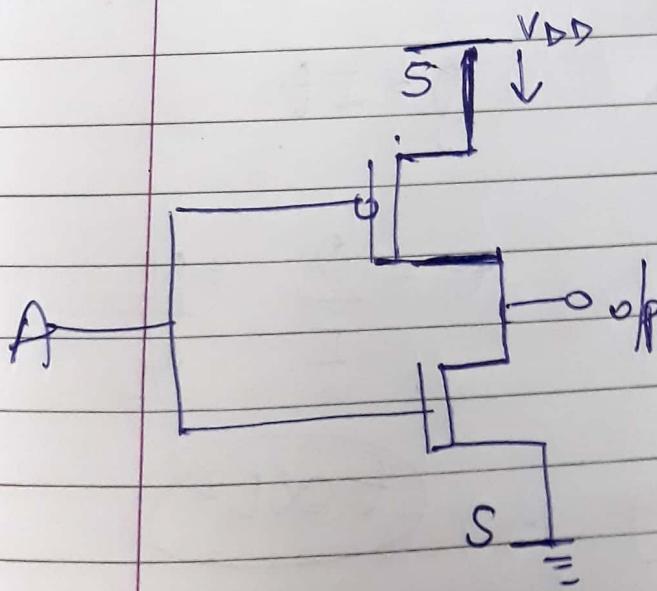


* $V_{GS} < V_T$ for operation

when $A = S$

$$\underline{V_{GS} = 0}$$

PMOS coupled with N-MOS



A	O/P
0	0
1	1

At a time only one is on
Over the steady state → Only is

A=0 PMOS on
only

Capacitor can charge till $O/P = \underline{SV - V_{DD}}$

A=S NMOS on



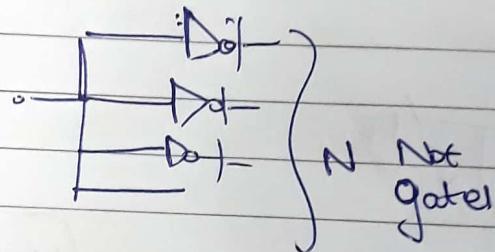
Resistance in series with open circuit

→ Capacitor voltage can rise to $SV = V_{DD}$

⇒ "No DC power loss"

Moore's
law

Capacitance?



$$Capacitance = NWL C_{ox}$$

$$I \propto 1/L$$

Incentive to decrease length
charging current ↑

$$Q = It$$

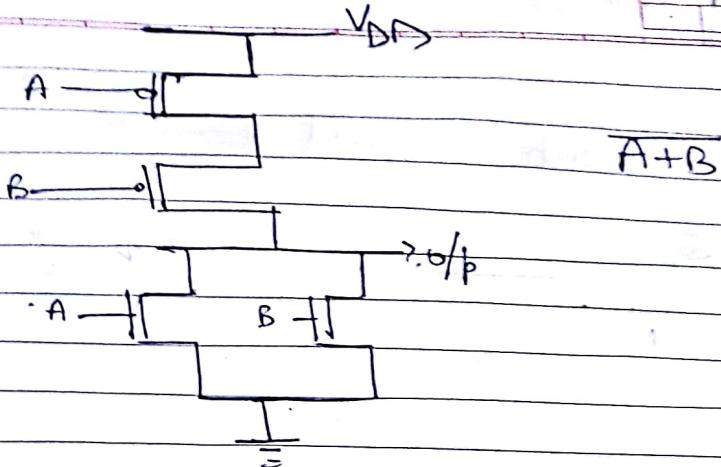
Load decrease

Charging time $\propto L^2$

$$t = \frac{Q}{I} = \frac{\rho L}{d_L}$$

As we decrease length switching
time will decrease

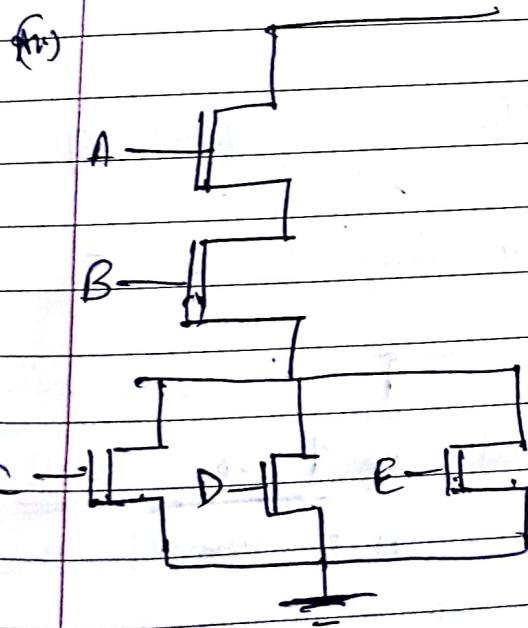
$$t \propto L^2$$



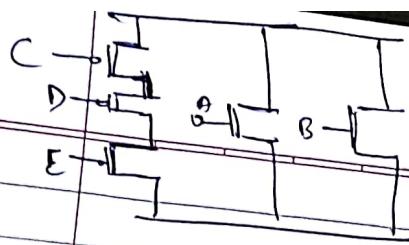
A	B	O/p
0	0	S
0	1	0
1	0	0
1	1	0

→ pmos stack is always inverted if nmos is in series

(Q) Doesn't now know pmos stack full funct & pmos stack

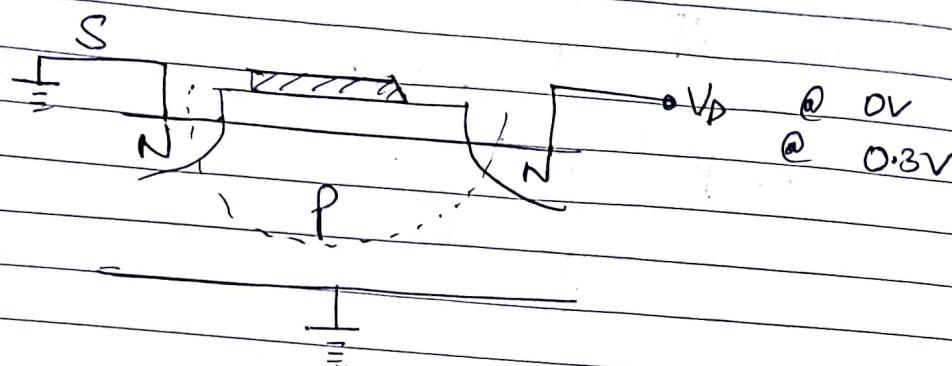


$$O/p = (C+D+E) \cdot A \cdot B$$

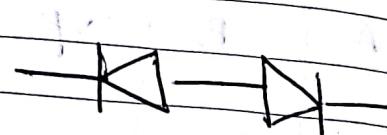


Page No.:

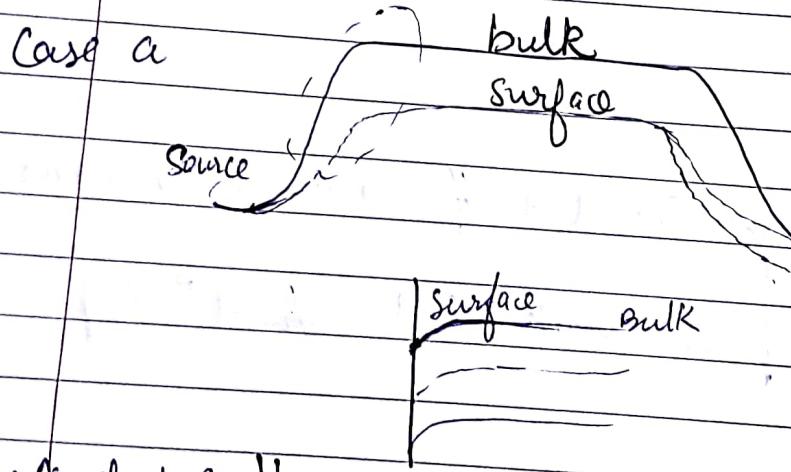
Sub-threshold



Away from SC in bulk:



p=n back to back



~~if drop is~~
In small area
the drift
current is very
small

At $V_D = 0$, diffusion is equal & opp
 $\Rightarrow I = 0$
diffusion cancels out

at $V_D = 0.3 \rightarrow I \neq 0$ to some value

but on $\uparrow V_D$ more (long
channel)

not much \uparrow in I



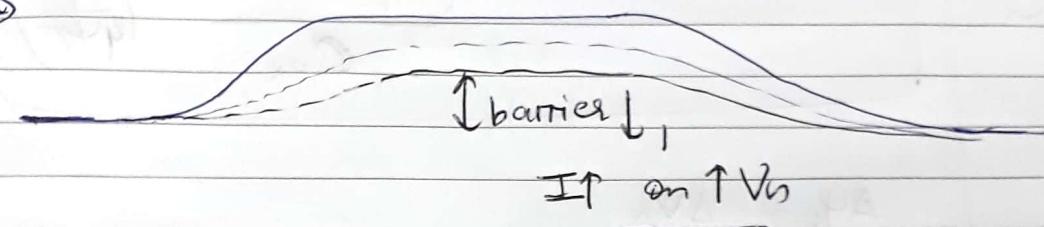
$V_D > 0$ ($V_D \uparrow$ current constⁿ)

diffⁿ from $S \rightarrow D$, no of carrier

Source
} same even if N_D same
Same $\rightarrow I \rightarrow$ same

$V_L \rightarrow \text{const}^+$, $V_D \uparrow \rightarrow I \approx \text{const}$

$V_L \uparrow$, $V_D = \text{const}^+ \Rightarrow I \uparrow$ as barrier on right ↓



$$V_H = \psi_s + \frac{Q_s}{C_{ox}}$$

$$V_H = \psi_s + \left(\frac{2\epsilon g N_A \psi_s}{C_{ox}} \right)^{1/2} / \text{deflection region}$$

$$I \propto e^{\psi_{\text{barrier}}/kT}$$

$$\psi_s < 2\psi_F \quad (\text{But very close to } \pm)$$

$$V_H - V_T = \psi_s + \left(\frac{2\epsilon g N_A \psi_s}{C_{ox}} \right)^{1/2}$$

$$= (\psi_s - 2\psi_F) - \left(\frac{2\epsilon g N_A 2\psi_F}{C_{ox}} \right)^{1/2} + \left(\frac{2\epsilon g N_A \psi_s}{C_{ox}} \right)^{1/2}$$

$$\text{Now as } \psi_s - 2\psi_F \ll 2\psi_F$$

$$\left(\frac{2\epsilon g N_A \psi_s}{C_{ox}} \right)^{1/2} = \left(2\epsilon g N_A (\psi_s - 2\psi_F + 2\psi_F) \right)^{1/2}$$

$$= \left(2\epsilon g N_A 2\psi_F \right)^{1/2} \left[1 + \frac{\psi_s - 2\psi_F}{2\psi_F} \right]^{1/2}$$

$$V_A - V_T = (\psi_s - 2\psi_F) (m)$$

Page No. _____

$$\star m = 1 + \frac{(2e q N_A 2\psi_F)^{1/2}}{C_{ox}} \left(\frac{1}{4\psi_F} \right)$$

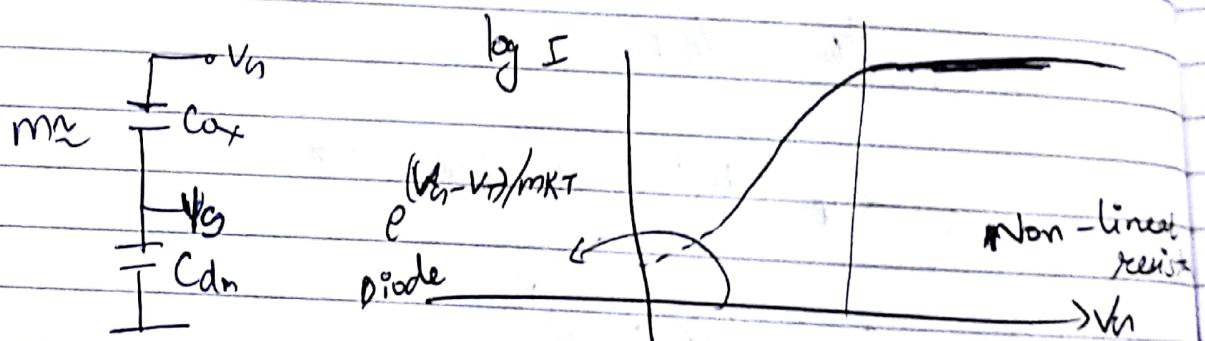


$$V_D - V_T = (\psi_s - 2\psi_F) (1 + m)$$

$$m = \frac{(2e q N_A 2\psi_F)^{1/2}}{C_{ox}} \left(\frac{1}{4\psi_F} \right)$$

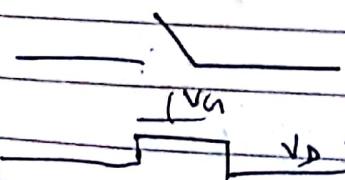
$$\Delta Y_S = \frac{\Delta V_D}{m}$$

$$I \propto e^{(V_D - V_T)/mK_T}$$



\star Subthreshold slope (s_s) = $\left(\frac{d \log (I)}{d V_D} \right)^{-1}$

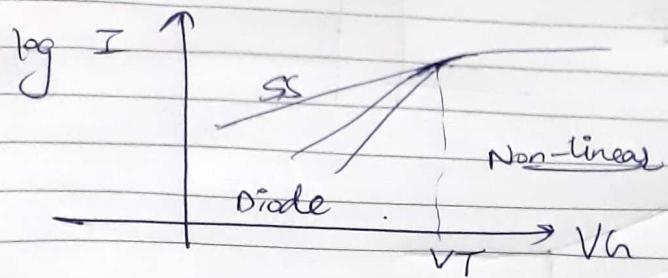
$\sim 60 \text{ mV/decade}$



V_D will always be there in a circuit, hence some I will be there as band is

degenerate

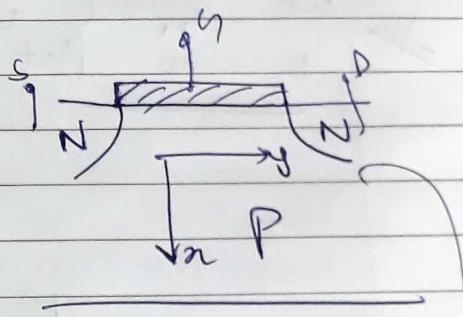
• we want to lower SS



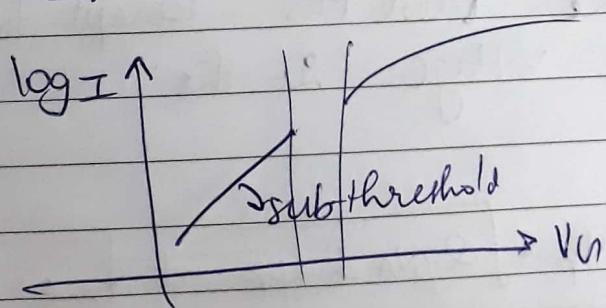
NON-Ideal MOS

① I_D , NMOS, $V_T = 0.7V$, $V_{DS} = 0.5V$, $V_{GS} = 0.7V$

$$\textcircled{2} \quad Q_I = C_{ox} (V_g - V_T - V(y))$$

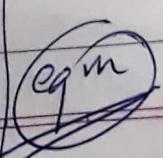


at $V_D = V_T$ we don't have any current
exp.



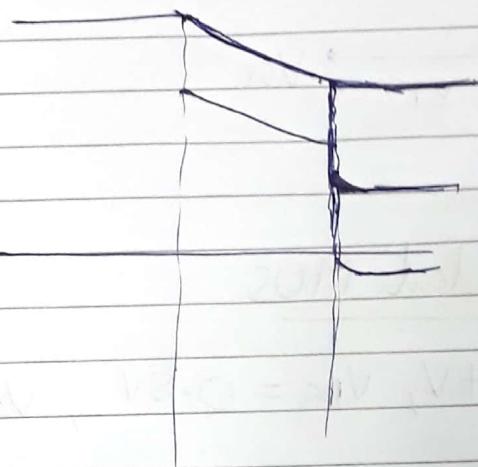
at drain the diode has larger depletion region

while at source the depletion region is very small ($V=0$)

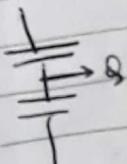


ϕ_m :-
for moscap:

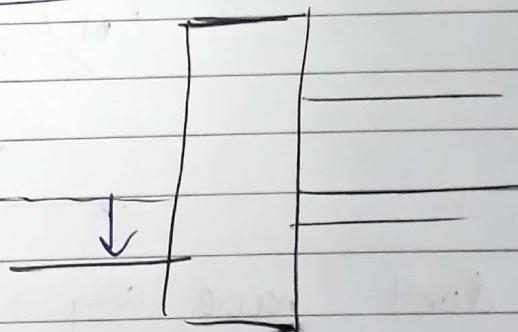
$\phi_{mS} = \phi_m -$
 $= 0$
(For ideal)



S250 USP



- * we applied a gate biased such that the band became flat

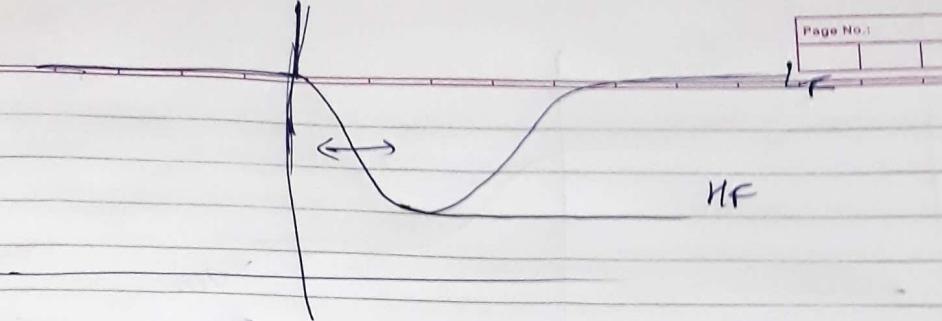


now

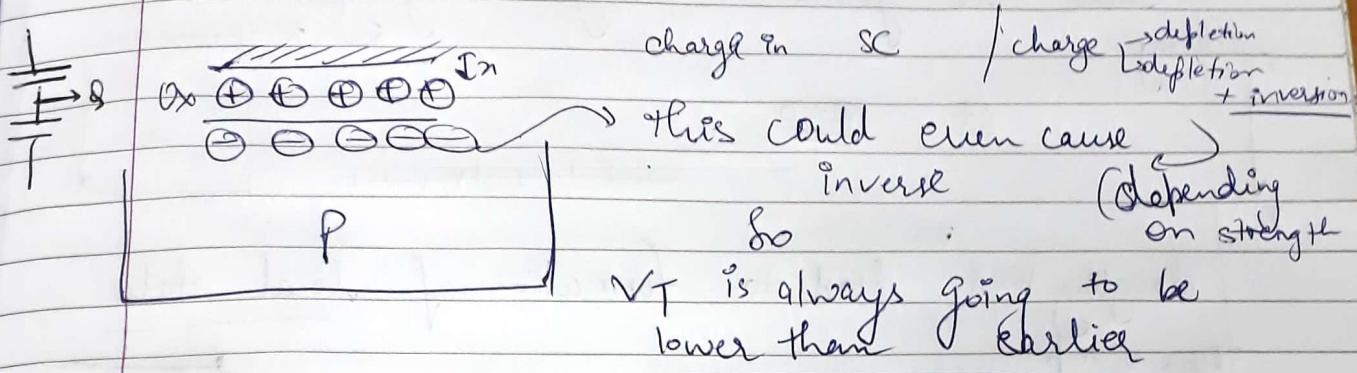
So this is just like ideal Mos except for
the addⁿ/extra voltage so the
expⁿ of V_T

for non-ideal

$$V_T = \alpha \psi_F + \sqrt{2qN_A \alpha \psi_F + \phi_{mS}}$$



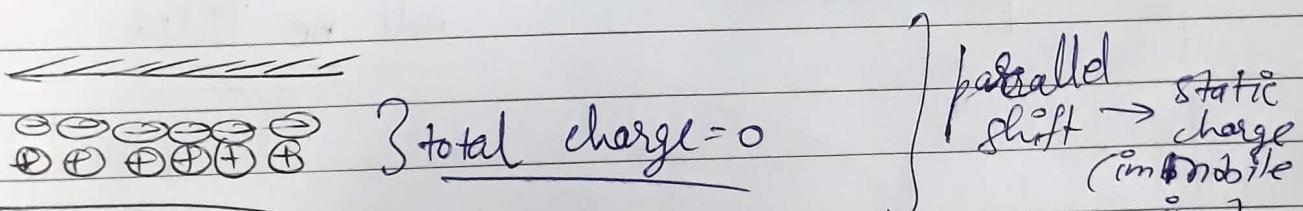
Everything will be parallelly shifted (left/right)



what Voltage we should apply to make it flat-band.

Electric field:
$$\frac{-\sigma}{\epsilon} x = \Delta V_{FB}$$

$$V_{FB} = - \int_0^{x_n} \frac{\sigma}{\epsilon} dx \quad \text{for a dist}^n$$



If charges are mobile \rightarrow ions as we sweep V_{FB} \rightarrow stretch out

$\rightarrow v_m$

There are gonna be many dangling bonds \rightarrow unsatisfied

y

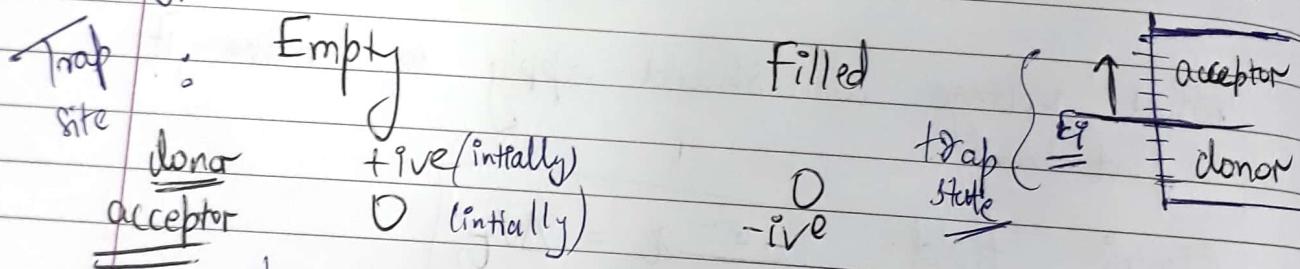
at $n=0$

+++ + + + + + + +

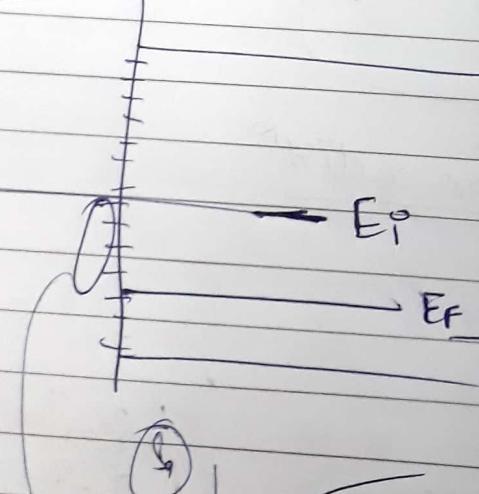
Si

dangling bonds lead to formation of local state

Types of trap

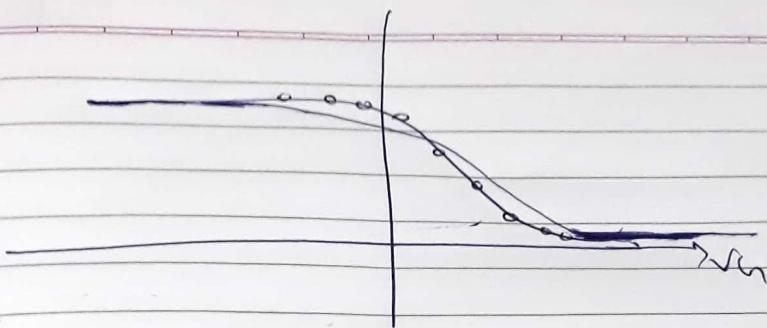


upto fermi-level
the state should
be filled

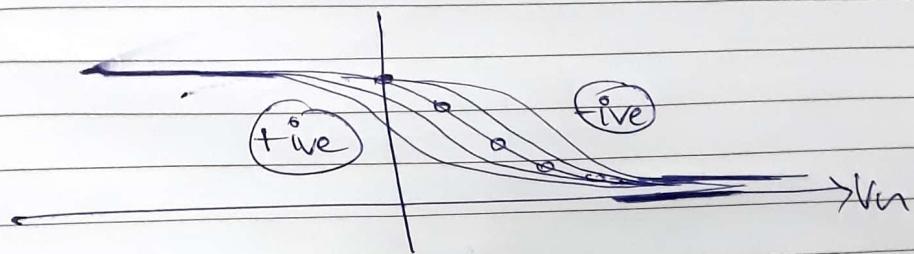


below E_F
all be filled

E_F crosses E_F \rightarrow all donors will be occupied
net charge \rightarrow -ive charge & \downarrow



for immobile charges



all we increase $v_n \rightarrow$ the charge will change & we get a curve somewhat below \oplus & \ominus five immobile charge.